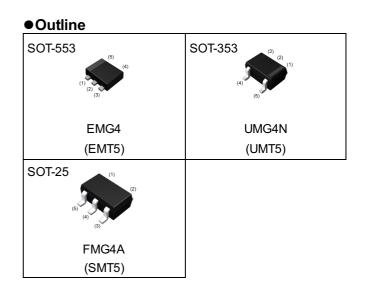
EMG4 / UMG4N / FMG4A

Emitter common(dual digital transistors)

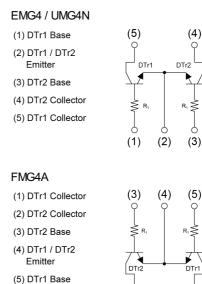
| Parameter | DTr1 and DTr2 | |
|------------------|---------------|--|
| V _{CEO} | 50V | |
| Ι _C | 100mA | |
| R ₁ | 10kΩ | |

Features

- 1)Two DTC114T chips in a EMT or UMT or SMT package.
- 2)Mounting cost and area can be cut in half.



Inner circuit



6

(2)

d

(1)

• Application INVERTER, INTERFACE, DRIVER

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|----------|------------------------|-----------------|----------------|-------------------|--------------------|---------------------------------|---------|
| EMG4 | SOT-553 (EMT5) | 1616 | T2R | 180 | 8 | 8000 | G4 |
| UMG4N | SOT-353 (UMT5) 2021 | 2021 | TR | 180 | 8 | 3000 | G4 |
| FMG4A | SOT-25 (SMT5) | 2928 | T148 | 180 | 8 | 3000 | G4 |

● Absolute maximum ratings (T_a = 25°C)

<For DTr1 and DTr2 in common>

| Parameter | | Symbol | Values | Unit | | |
|------------------------------|-------|------------------|--------------------------------|------|----------|--|
| Collector-base voltage | | V_{CBO} | 50 | V | | |
| Collector-emitter voltage | | V _{CEO} | 50 | V | | |
| Emitter-base voltage | | V _{EBO} | 5 | V | | |
| Collector current | | ۱ _C | 100 | mA | | |
| | EMG4 | | P _D ^{*1*2} | 150 | mW/Total | |
| Power dissipation | UMG4N | | P _D ^{*1*2} | 150 | | |
| | FMG4A | | P _D ^{*1*3} | 300 | | |
| Junction temperature | | Tj | 150 | °C | | |
| Range of storage temperature | | T _{stg} | -55 to +150 | °C | | |

• Electrical characteristics (T_a = 25°C)

<For DTr1 and DTr2 in common>

| Deremeter | Cumphal | Conditions | Values | | | Unit | |
|--|---|--|--------|----------------|-----|-------|--|
| Parameter | Symbol | Conditions | | Min. Typ. Max. | | Orint | |
| Collector-base breakdown voltage | BV _{CBO} | V _{CBO} Ι _C = 50μΑ | | - | - | V | |
| Collector-emitter breakdown voltage | BV_{CEO} | | | - | - | V | |
| Emitter-base breakdown voltage | BV_{EBO} | | | - | - | V | |
| Collector cut-off current | Collector cut-off current | | - | - | 500 | nA | |
| Emitter cut-off current | I _{EBO} | V _{EB} = 4V | - | - | 500 | nA | |
| Collector-emitter saturation voltage | lector-emitter saturation voltage V _{CE(sat)} | | I | - | 300 | mV | |
| DC current gain h _{FE} Input resistance R ₁ | | V _{CE} = 5V, I _C = 1mA | 100 | 250 | 600 | - | |
| | | - | 7 | 10 | 13 | kΩ | |
| Transition frequency | cansition frequency f_T^{*4} $V_{CE} = 10V, I_E = -5mA$ f = 100MHz | | - | 250 | - | MHz | |

*1 Each terminal mounted on a reference land.

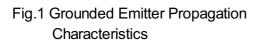
*2 120mW per element must not be exceeded.

*3 200mW per element must not be exceeded.

*4 Characteristics of built-in transistor.



<For DTr1 and DTr2 in common>



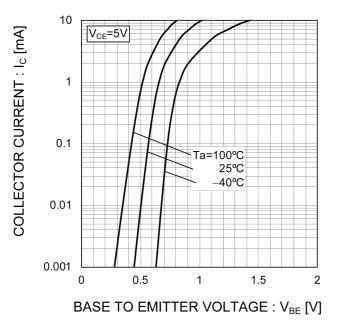
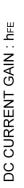


Fig.3 DC Current Gain vs. Collector Current

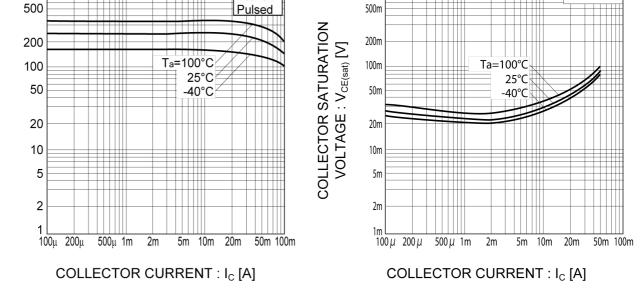
Fig.4 Collector-Emitter Saturation Voltage vs. Collector Current

COLLECTOR TO EMITTER

VOLTAGE : V_{CE} [V]

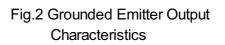


1k



3/6

VCE=5V



100

80

60

40

20

0

0

1

COLLECTOR CURRENT: I_c [mA]

Ta = 25°C Pulsed I_B= 500µA

450µA

400µA

350µA

300µА 250µА

200µA

150µA

100µA

50µA

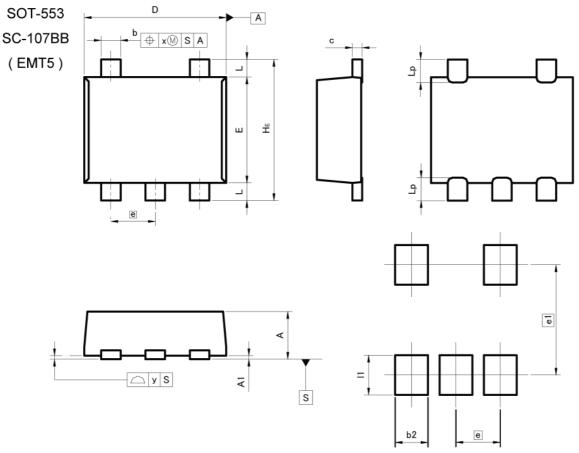
0A

10

Ic/I_B=10



Dimensions



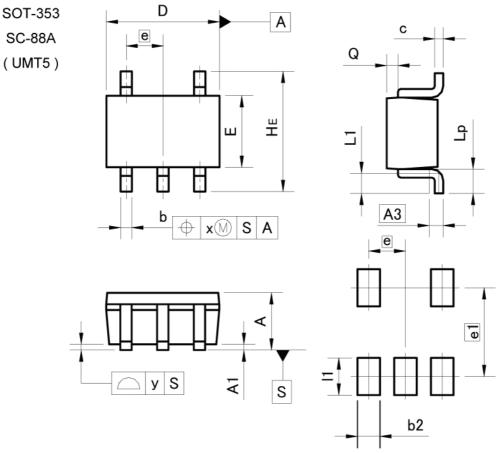
Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIM | ETERS | INCHES | | |
|-----|-------|------------|--------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| A | 0.45 | 0.55 | 0.018 | 0.022 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| b | 0.17 | 0.27 | 0.007 | 0.011 | |
| с | 0.08 | 0.18 | 0.003 | 0.007 | |
| D | 1.50 | 1.70 | 0.059 | 0.067 | |
| E | 1.10 | 1.30 | 0.043 | 0.051 | |
| е | 0.50 | | 0.020 | | |
| HE | 1.50 | 1.70 | 0.059 | 0.067 | |
| L | 0.10 | 0.30 | 0.004 | 0.012 | |
| Lp | - | 0.35 | - | 0.014 | |
| x | - | 0.10 | - | 0.004 | |
| У | - | 0.10 | - | 0.004 | |
| | | | _ | | |
| DIM | MILIM | MILIMETERS | | HES | |
| DIM | MIN | MAX | MIN | MAX | |
| b2 | - | 0.37 | - | 0.015 | |
| e1 | 1.25 | | 0.049 | | |
| 1 | — | 0.45 | - | 0.018 | |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

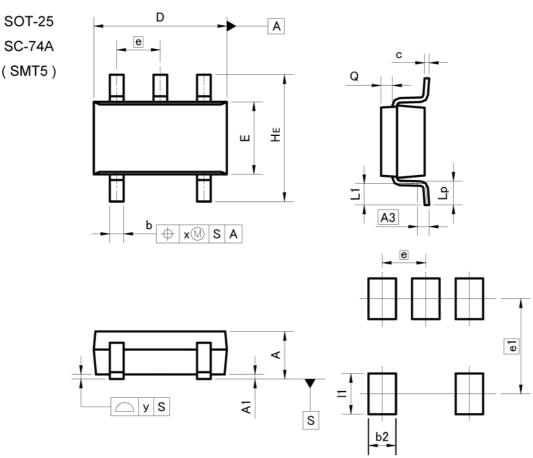
| DIM | MILIMETERS | | INC | HES | |
|-----|------------|-------|---------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| А | 0.80 | 1.00 | 0.031 | 0.039 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| A3 | 0. | 25 | 0.0 | 10 | |
| b | 0.15 | 0.30 | 0.006 | 0.012 | |
| С | 0.10 | 0.20 | 0.004 | 0.008 | |
| D | 1.90 | 2.10 | 0.075 | 0.083 | |
| E | 1.15 | 1.35 | 0.045 | 0.053 | |
| е | 0. | 65 | 0.026 | | |
| HE | 2.00 | 2.20 | 0.079 | 0.087 | |
| L1 | 0.20 | 0.50 | 0.008 | 0.020 | |
| Lp | 0.25 | 0.55 | 0.010 | 0.022 | |
| Q | 0.10 | 0.30 | 0.004 | 0.012 | |
| х | - | 0.10 | - | 0.004 | |
| У | - | 0.10 | · | 0.004 | |
| | | | | | |
| DIM | MILIM | ETERS | INC | HES | |
| DIM | MIN | MAY | MIN | MAY | |

| DIM | MILIMETERS | | INCHES | | |
|-----|------------|------|--------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| b2 | - | 0.40 | - | 0.016 | |
| e1 | 1.55 | | 0.0 | 61 | |
| 1 | - 0.65 | | - | 0.026 | |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIM | ETERS | INC | HES |
|-----|-------|-------|----------|-------|
| DIM | MIN | | MIN | MAX |
| А | 1.00 | 1.30 | 0.039 | 0.051 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A3 | 0. | 25 | 0.0 | 10 |
| b | 0.25 | 0.40 | 0.010 | 0.016 |
| С | 0.09 | 0.25 | 0.004 | 0.010 |
| D | 2.80 | 3.00 | 0.110 | 0.118 |
| Е | 1.50 | 1.80 | 0.059 | 0.071 |
| е | 0. | 95 | 0.037 | |
| HE | 2.60 | 3.00 | 0.102 | 0.118 |
| L1 | 0.30 | 0.60 | 0.012 | 0.024 |
| Lp | 0.40 | 0.70 | 0.016 | 0.028 |
| Q | 0.20 | 0.30 | 0.008 | 0.012 |
| х | - | 0.20 | — | 0.008 |
| У | - | 0.10 | - | 0.004 |

| DIM | MILIMETERS | | INCHES | | |
|-----|-------------|------|-------------|-------|--|
| | MIN | MAX | MIN | MAX | |
| b2 | - | 0.60 | — | 0.024 | |
| e1 | 2.10 | | 0.0 | 83 | |
| 1 | | 0.90 | | 0.035 | |

Dimension in mm/inches



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| (Note1) Medical Equipment Classification of the Specific Applications |
|---|
|---|

| JAPAN | USA | EU | CHINA |
|--------|---------|------------|---------|
| CLASSⅢ | CLASSⅢ | CLASS II b | |
| CLASSⅣ | CLASSII | CLASSⅢ | CLASSII |

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